

**SF2173E** 

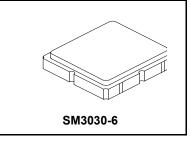
- Surface Mount 3.0 x 3.0 mm Package
- Complies with Directive 2002/95/EC (RoHS)



### **Absolute Maximum Ratings**

Rating	Value	Units
Input Power Level	10	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Maximum Soldering Profile, 5 cycles/ 10 seconds maximum	265	°C

# 2350 MHz **SAW Filter**

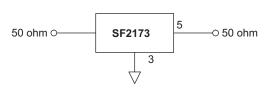


#### **Electrical Characteristics**

Characteristic	Sym	Notes	Min	Тур	Max	Units	
Center Frequency				2350		MHz	
Insertion Loss, 2300 to 2400 MHz				3.0	4.2	dB	
Amplitude Ripple, 2300 to 2400 MHz				1.5	3.1		
Attenuation, Referenced to 0 dB:							
DC to 2050 MHz			23	28			
2050 to 2170 MHz			30	32			
2170 to 2250 MHz	24 40 18 38		dB				
2450 to 2550 MHz							
2550 to 4000 MHz			27	31			
Input/Output VSWR, 2300 to 2400 MHz				2.2	2.5		
Source Impedance				50			
Load Impedance				50		Ω	
Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint						
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	862, YWWS						
Standard Reel Quantity Reel Size 7 Inch	500 Pieces/Reel						
Reel Size 13 Inch			3000	Pieces/Reel			

#### **Electrical Connections**

Connection	Terminals
Input	2
Output	5
Case Ground	All others





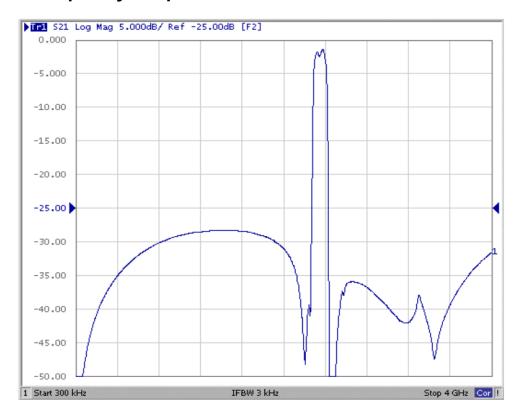
### CAUTION: Electrostatic Sensitive Device. Observe precautions for handling. NOTES:

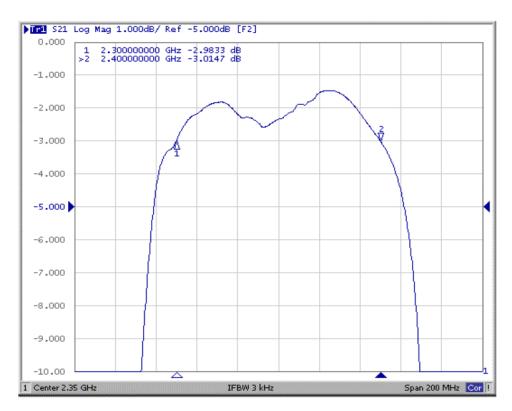
- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to  $50 \Omega$  and measured with  $50 \Omega$  network analyzer.
  Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
  Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.
  "LRIP" or "L" after the part number indicates "low rate initial production" and "ENG" or "E" indicates "engineering prototypes."
- 3.
- The design, manufacturing process, and specifications of this filter are subject to change.

  Either Port 1 or Port 2 may be used for either input or output in the design. However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design. 5. 6.
- US and international patents may apply.

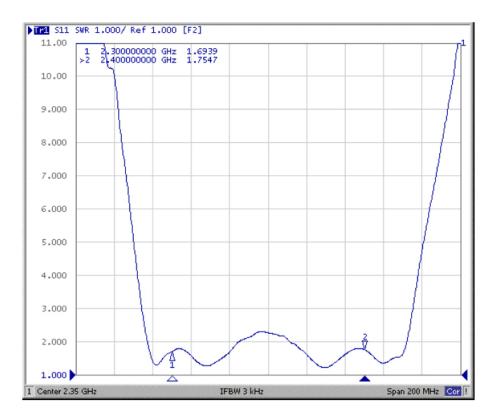
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# **SF2173E Frequency Response Plots**

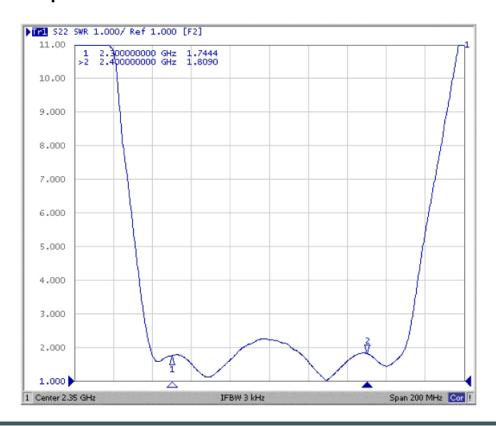




## **SF2173E Input VSWR**

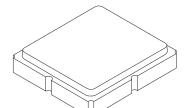


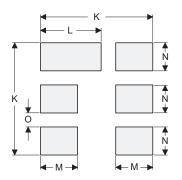
### **SF2173E Output VSWR**



# **SM3030-6 Case**

# 6-Terminal Ceramic Surface-Mount Case 3.0 X 3.0 mm Nominal Footprint





**PCB Footprint Top View** 

### **Case and PCB Footprint Dimensions**

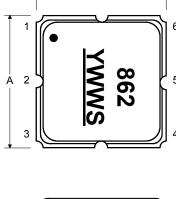
Dimension		mm			Inches	
Difficusion	Min	Nom	Max	Min	Nom	Max
Α	2.87	3.00	3.13	0.113	0.118	0.123
В	2.87	3.00	3.13	0.113	0.118	0.123
С	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.90	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
Н	1.37	1.50	1.63	0.054	0.059	0.064
I	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
K		3.20			0.126	
L		1.70			0.067	
М		1.05			0.041	
N		0.81			0.032	
0		0.38			0.015	

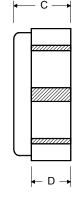
### **Case Materials**

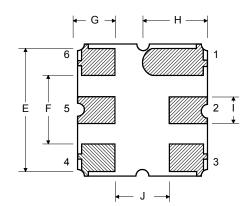
Materials				
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel			
Lid Plating	2.0 to 3.0 µm Nickel			
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic			
Pb Free				

### **TOP VIEW**

- B -

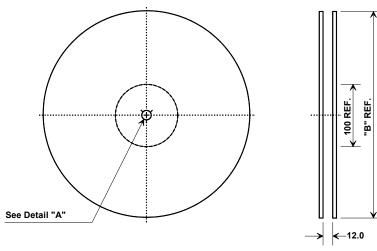




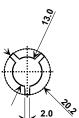


**BOTTOM VIEW** 

### **Tape and Reel Specifications**



•	'B"	Quantity Per Reel	
Inches	millimeters	Quantity : or ricor	
7	178	500	
13	330	3000	



### **COMPONENT ORIENTATION and DIMENSIONS**

Carrier Tape Dimensions				
Ao	3.35 mm			
Во	3.35 mm			
Ko	1.40 mm			
Pitch	8.0 mm			
W	12.0 mm			

